

WLJ.060

U.S. APPLICATION NO. (IF KNOWN, SEE 37 CFR

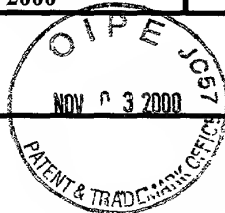
09/ 674 660

INTERNATIONAL APPLICATION NO.  
**PCT/GB00/00796**INTERNATIONAL FILING DATE  
**6 MARCH 2000**PRIORITY DATE CLAIMED  
**4 MARCH 1999**

TITLE OF INVENTION

**CHLOROTRIFLUORINE GAS GENERATOR SYSTEM**

APPLICANT(S) FOR DO/EO/US

**Jyoti Kiron BHARDWAJ et al.**

Applicant herewith submits to the United States Designated/Elected Office (DO/EO/US) the following items and other information:

1. ☒ This is a **FIRST** submission of items concerning a filing under 35 U.S.C. 371.
2. ☐ This is a **SECOND** or **SUBSEQUENT** submission of items concerning a filing under 35 U.S.C. 371.
3. ☒ This is an express request to begin national examination procedures (35 U.S.C. 371(f)) at any time rather than delay examination until the expiration of the applicable time limit set in 35 U.S.C. 371(b) and PCT Articles 22 and 39(1).
4. ☐ A proper Demand for International Preliminary Examination was made by the 19th month from the earliest claimed priority date.
5. ☒ A copy of the International Application as filed (35 U.S.C. 371 (c) (2))
  - a. ☒ is transmitted herewith (required only if not transmitted by the International Bureau).
  - b. ☐ has been transmitted by the International Bureau.
  - c. ☐ is not required, as the application was filed in the United States Receiving Office (RO/US).
6. ☐ A translation of the International Application into English (35 U.S.C. 371(c)(2)).
7. ☒ A copy of the International Search Report (PCT/ISA/210).
8. ☐ Amendments to the claims of the International Application under PCT Article 19 (35 U.S.C. 371 (c)(3))
  - a. ☐ are transmitted herewith (required only if not transmitted by the International Bureau).
  - b. ☐ have been transmitted by the International Bureau.
  - c. ☐ have not been made; however, the time limit for making such amendments has NOT expired.
  - d. ☐ have not been made and will not be made.
9. ☐ A translation of the amendments to the claims under PCT Article 19 (35 U.S.C. 371(c)(3)).
10. ☒ An oath or declaration of the inventor(s) (35 U.S.C. 371 (c)(4)).
11. ☐ A copy of the International Preliminary Examination Report (PCT/IPEA/409).
12. ☐ A translation of the annexes to the International Preliminary Examination Report under PCT Article 36 (35 U.S.C. 371 (c)(5)).

**Items 13 to 20 below concern document(s) or information included:**

13. ☐ An Information Disclosure Statement under 37 CFR 1.97 and 1.98.
14. ☒ An assignment document for recording. A separate cover sheet in compliance with 37 CFR 3.28 and 3.31 is included.
15. ☒ A **FIRST** preliminary amendment.
16. ☐ A **SECOND** or **SUBSEQUENT** preliminary amendment.
17. ☐ A substitute specification.
18. ☐ A change of power of attorney and/or address letter.
19. ☐ Certificate of Mailing by Express Mail
20. ☐ Other items or information:

U.S. APPLICATION NO. (UNKNOWN) SEE 37 CFR <div style="font-size: 2em; font-weight: bold; margin-top: 5px;">097/ 674 860</div>		INTERNATIONAL APPLICATION NO <div style="font-weight: bold; margin-top: 5px;">PCT/GB00/00796</div>		ATTORNEY'S DOCKET NUMBER <div style="font-weight: bold; margin-top: 5px;">WLJ.060</div>	
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21. The following fees are submitted: <b>BASIC NATIONAL FEE ( 37 CFR 1.492 (a) (1) - (5)) :</b> <input type="checkbox"/> Neither international preliminary examination fee (37 CFR 1.482) nor international search fee (37 CFR 1.445(a)(2)) paid to USPTO and International Search Report not prepared by the EPO or JPO ..... <b>\$1,000.00</b> <input checked="" type="checkbox"/> International preliminary examination fee (37 CFR 1.482) not paid to USPTO but International Search Report prepared by the EPO or JPO ..... <b>\$860.00</b> <input type="checkbox"/> International preliminary examination fee (37 CFR 1.482) not paid to USPTO but international search fee (37 CFR 1.445(a)(2)) paid to USPTO ..... <b>\$710.00</b> <input type="checkbox"/> International preliminary examination fee paid to USPTO (37 CFR 1.482) but all claims did not satisfy provisions of PCT Article 33(1)-(4) ..... <b>\$690.00</b> <input type="checkbox"/> International preliminary examination fee paid to USPTO (37 CFR 1.482) and all claims satisfied provisions of PCT Article 33(1)-(4) ..... <b>\$100.00</b> <div style="text-align: right; font-weight: bold; margin-top: 5px;">ENTER APPROPRIATE BASIC FEE AMOUNT =</div>				<b>CALCULATIONS PTO USE ONLY</b> <div style="border: 1px solid black; height: 100px; margin-top: 5px;"></div>	
Surcharge of <b>\$130.00</b> for furnishing the oath or declaration later than <input type="checkbox"/> 20 <input type="checkbox"/> 30 months from the earliest claimed priority date (37 CFR 1.492 (e)).				<div style="border: 1px solid black; padding: 2px;">\$0.00</div>	
CLAIMS	NUMBER FILED	NUMBER EXTRA	RATE		
Total claims	12 - 20 =	0	x \$18.00	\$0.00	
Independent claims	1 - 3 =	0	x \$80.00	\$0.00	
Multiple Dependent Claims (check if applicable).				<input type="checkbox"/>	\$0.00
TOTAL OF ABOVE CALCULATIONS =				\$860.00	
Reduction of 1/2 for filing by small entity, if applicable. Verified Small Entity Statement must also be filed (Note 37 CFR 1.9, 1.27, 1.28) (check if applicable).				<input type="checkbox"/>	\$0.00
SUBTOTAL =				\$860.00	
Processing fee of <b>\$130.00</b> for furnishing the English translation later than <input type="checkbox"/> 20 <input type="checkbox"/> 30 months from the earliest claimed priority date (37 CFR 1.492 (f)).				\$0.00	
TOTAL NATIONAL FEE =				\$860.00	
Fee for recording the enclosed assignment (37 CFR 1.21(h)). The assignment must be accompanied by an appropriate cover sheet (37 CFR 3.28, 3.31) (check if applicable).				<input checked="" type="checkbox"/>	\$40.00
TOTAL FEES ENCLOSED =				\$900.00	
				Amount to be: refunded	\$
				charged	\$

☒ A check in the amount of **\$900.00** to cover the above fees is enclosed.  
  
☐ Please charge my Deposit Account No. \_\_\_\_\_ in the amount of \_\_\_\_\_ to cover the above fees.  
 A duplicate copy of this sheet is enclosed.  
  
☒ The Commissioner is hereby authorized to charge any fees which may be required, or credit any overpayment to Deposit Account No. **50-0238** A duplicate copy of this sheet is enclosed.

**NOTE: Where an appropriate time limit under 37 CFR 1.494 or 1.495 has not been met, a petition to revive (37 CFR 1.137(a) or (b)) must be filed and granted to restore the application to pending status.**

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SIGNATURE

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 ADAM C. VOLENTINE  
 NAME
 

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 33289  
 REGISTRATION NUMBER
 

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 NOV. 3, 2000  
 DATE
 

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09/674660

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

RECEIVED 03 NOV 2000

In Re Patent Application of :  
Jyoti Kiron BHARDWAJ et al. : Attn: Applications Branch  
Serial No. [NEW] : Attorney Docket No.: WLJ.060  
Filed: November 3, 2000 :  
Title: CHLOROTRIFLUORINE GAS GENERATOR SYSTEM

**PRELIMINARY AMENDMENT**

Honorable Commissioner of  
Patents and Trademarks,  
Washington, D.C. 20231

Sir:

Preliminary to the examination of the above-identified application, please  
enter the following amendments and consider the following remarks:

**IN THE CLAIMS:**

Please cancel claim 13 without prejudice.

Please amend the claims as follows:

Claim 3, line 1, delete "or claim 2".

Claim 4, line 1, change "any one of claims 1 to 3" to --claim 1--.

Claim 5, line 1, change "any one of claims 1 to 4" to --claim 1--.

Claim 9, line 2, change "any one of claims 1 to 8" to --claim 1--.

**REMARKS**

By this Preliminary Amendment, claim 13 has been canceled, and claims 3, 4, 5, and 9 have been amended to eliminate the multiple dependent claims. Entry of this Preliminary Amendment is respectfully requested.

Respectfully submitted,

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Date: November 3, 2000

09/674660

"Chlorotrifluorine Gas Generator System"

Chlorotrifluorine ( $\text{ClF}_3$ ) is known to be a likely candidate to achieve an improved etch process capability and has recently become increasingly utilised as a "dry chamber-clean" gas to remove very effectively deposits and build-up after other plasma processes. This is more effective and used in preference to gases such as  $\text{NF}_3$ , which are also highly toxic, but require plasma or other excitation means to allow etching at acceptable rates.

The prior art comprises two alternative methods of  $\text{ClF}_3$  supply, either using a conventional cylinder containing the precursor gas or by local electrolytic cell generation. Cylinder  $\text{ClF}_3$  gas delivery systems are most commonly used and have been discussed in detail by Verma et al (Semiconductor International, July 1997, p253). Issues such as compatibility of installation materials and thermal gradients require particular attention. These design considerations can have a significant impact on the overall performance of the process.

Supply of  $\text{ClF}_3$  has been available in liquid cylinder form and, very recently, developments have focused on the availability of "dry" cartridge delivery systems. This allows the delivery of  $\text{ClF}_3$  (in a nitrogen carrier gas), with the advantages that there are neither liquid filled cylinders of extremely hazardous  $\text{ClF}_3$  to be transported nor any special storage requirements on-site, as the dry cartridge is solid at ambient temperatures. A limitation

of either the liquid cylinder or dry cartridge  $\text{ClF}_3$  delivery system is that they are both subject to fluctuations in the ambient conditions, which could affect the process reproducibility.  $\text{ClF}_3$  (which is a liquid at ambient temperature) is delivered from a conventional cylinder as a low vapour-pressure gas. To achieve the high gas flow rates and pressures required for processing, a single cylinder using an external-heating jacket is commonly used. This poses additional facilitation and safety requirements in order to prevent gas condensation in the delivery lines and components. The situation may be further aggravated depending upon application. For example if the gas is used in applications where it may be switched with another process gas, then the changes in the flow demands of the process may cause the gas to liquefy in the gas lines. This is because of the variable pressure, temperature and flow parameters experienced by the gas delivery system during this process.

Newer delivery systems based on electrolytic cell generation overcome some of these limitations. Such systems are only just becoming commercially available. An example is a fluorine gas generator cell as described in US Patent No. 5688384. However a dedicated  $\text{ClF}_3$  delivery installation is still needed. Limitations of this dry cartridge  $\text{ClF}_3$  delivery system include gas flow fluctuations caused by changes in the ambient conditions which will, in turn, affect the process reproducibility. The cost of the

process gas is similar to that for supply of  $\text{ClF}_3$  in liquid form but the dry cartridges require exchanging and this will require a service infrastructure and support to be established. In addition, this method only allows  $\text{ClF}_3$  to be generated in the presence of an  $\text{N}_2$  carrier gas.

$\text{ClF}_3$  suffers from a combination of increased cost over existing chemistries, greater health and safety risks and limited commercial availability. These factors combine to make the economics and practicalities of implementing this chemistry potentially difficult and/or the installation and transportation thereof extremely hazardous.

According to the invention there is provided a  $\text{ClF}_3$  gas generation system wherein supply sources of chlorine and fluorine are connected into a gas reaction chamber enabling generation of  $\text{ClF}_3$  gas, and the reaction chamber has a valved outlet for the supply of the  $\text{ClF}_3$  gas.

The invention further extends to such a gas generator system wherein the valved outlet from the reaction chamber is connected to a single or multiple process chamber or processing tool or multiple tools in which the  $\text{ClF}_3$  gas will be utilised. A tool may have more than one chamber. This invention provides for the generation of  $\text{ClF}_3$  process gas on demand. The  $\text{ClF}_3$  is generated locally to the process tool through the direct combination of the precursor gases, fluorine and chlorine, under controlled temperature and pressure reaction conditions. The use of the individual precursor gases offers a considerable improvement over many

of the economic, and handling constraints of current methods of supplying  $\text{ClF}_3$ . In particular, the recent commercial availability of an appropriately scaled local high-purity fluorine generator overcomes many of the safety issues of handling pure high-purity fluorine required for the reaction.

"Locally" (or point of use) means that the delivery system is located near to a process chamber or a number of chambers or number of systems near to one another, so that the gases created can be delivered directly to the chamber or system for immediate use rather than being created off-site and transported in a suitable container for subsequent introduction into the apparatus.

Direct reaction of  $\text{Cl}_2$  and  $\text{F}_2$  allows the local generation of the  $\text{ClF}_3$ , although the specific reaction products resulting from the reaction may include other reaction by-products species in the form of  $\text{Cl}_x\text{F}_y$ , (and very small quantities of  $\text{Cl}_2$  and  $\text{F}_2$ ) but the dominant species can be maintained as  $\text{ClF}_3$ . Apart from the reaction by-product species, the generated gas can be formed to the same high purity levels as the precursor gases. This high purity is easier to maintain in a smaller scale reaction chamber compared to much larger commercial volume generation systems. For the majority of applications envisaged, the reaction by-product species defined above are not expected to represent any detrimental process issues over  $\text{ClF}_3$  alone. Other benefits of this invention include lower production



cost and ownership costs as well as reduced hazard to personnel.

The reaction chamber can be formed from high purity materials (such as those sold under the Trade Marks Monel (nickel/copper/iron alloy), Inconel (nickel/chromium/iron alloy) and Hastalloy (nickel/molybdenum/chromium/manganese/iron alloy)) which would not be financially feasible with large scale generation systems.

The gas generator for the invention operates with known precursor gases at or near atmospheric pressure, thus virtually eliminating the need for specialised gas delivery systems. Ideally though the gas generation system will be provided with a control system to control the rate of supply of gases from the two supply sources and through the valved outlet from the reaction chamber.

The reaction chamber may be operated at or near atmospheric pressure, going up the range from several Torr to 760 Torr. The reaction chamber temperature can be controlled at between ambient room temperature up to 600°C generally, but probably will lie within the range of 100 - 400°C. Differing temperatures may be maintained in at least 2 separate zones of the reaction chamber.

The most hazardous gas used in the installation will be  $\text{Cl}_2$ , which is already commonly used in most fabrication plants in the utilisation of semiconductor manufacturing techniques. Other than this, there are no extremely hazardous gases in the installation, until the process

demands gas generation (of fluorine gas, followed by  $\text{ClF}_3$ ). This reduces hazardous chemical storage problems and risk of corrosion etc. Long gas lines for the local generation of fluorine on demand from a central store on the installation to the processing environment are eliminated along with the associated risks. Specialised gas delivery systems, containing hazardous chemicals, to the process equipment are also eliminated, which reduces the level of safety precautions needed to protect the operator during use and during any maintenance operations. The generation of the process gas from the  $\text{ClF}_3$  gas generator is very competitive as compared with the cost requirement using high-pressure cylinders for the actual gas supply. There would be a significant reduction in the installation cost due to the reduced amount of pipe work for the additional gases and the associated safety requirements such as gas monitoring systems.

A chlorine supply source may comprise a cylinder of compressed chlorine or a chlorine generator. A fluorine supply source may be a fluorine generator.

The direct combination of precursor gases can provide  $\text{ClF}_3$  for the process chamber by passing the relatively safe precursor gases through a simple heated and pressure-controlled reaction chamber that is local to the tool. The design of the system will be such as to avoid possible adverse reactions during the combination of the precursor gases that may prejudice the overall process. The  $\text{ClF}_3$

5 reaction chamber design allows operation at pressures independent of the process chamber pressure. This can be achieved by allowing the gas product to flow into the process chamber via a pressure control system. The process chamber is then independent of the higher pressure in the reaction chamber and the delivery pressure of the supplied fluorine and chlorine.

10 The introduction of high purity gases removes the need to "polish" the generated  $\text{ClF}_3$  to remove unwanted impurities before passing into the process chamber. The generation of fluorine locally to the tool overcomes the commercial difficulties in obtaining high purity 100% fluorine in a high pressure cylinder and in the quantities required. The choice of supply of chlorine is from high-pressure cylinders, which are commercially readily available and commonly installed within the industry. Other appropriate methods of chlorine simply may be used. Mass flow controllers may be used to precisely meter the flow of  $\text{Cl}_2$  and  $\text{F}_2$  into the reaction chamber.

20 The safety requirements for the precursor gases are already commonplace for the targeted industry. This is not the case for chlorotrifluorine. The production of chlorotrifluorine within a sub-component of a process tool eliminates additional safety precautions that would need to be taken for the supply of such gas from a centralised store. The maintenance of the complete system is eased by

25

the absence of any  $\text{ClF}_3$ , when the system is not being used for processing.

5 The quantity of the generated gases can be regulated to that required for the specific application so that the gas consumption is optimised and excess generated gas avoided. The design of a custom-built fluorine-on-demand generator ensures that the  $\text{ClF}_3$  is only produced as required from the reaction chamber. The flow rates that can be achieved are not subject to gas delivery restrictions which might be prescribed for  $\text{ClF}_3$  delivery from a central store.

The invention may be performed in various ways and preferred embodiments thereof will now be described, by way of example, with reference to the accompanying drawing, in which:-

15 Figure 1 is a diagrammatic illustration of a typical system of the invention;

Figure 2 illustrates the effect of gas ratio variations on silicon etch rate; and

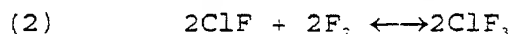
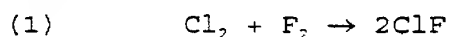
20 Figure 3 is a diagrammatic illustration of a further example of a direct combination  $\text{ClF}_3$  generator.

25 The system shown in the drawing is for supplying chlorotrifluorine to a process chamber 1 where a dry process utilising that gas is to take place. The  $\text{ClF}_3$  is delivered from a local reaction chamber 2 where precursor gases chlorine and fluorine are combined under conventional heat and pressure controlled conditions. The chlorine source is a cylinder 3 of compressed chlorine. The

fluorine source is a conventional fluorine generator 4. Appropriate valving will include valves provided at A, B, C and D for appropriate isolation and control means. Linked control systems 5 and 6 monitor and maintain the supply to and conditions in the chambers 1 and 2.

From the process chamber gases pass to an exhaust system 7, which in turn leads to an abatement tool 8 (which is usually needed). A bypass outlet 9 leads from the reaction chamber 2 to the exhaust system, whereby gases can be switched into the process chamber 1 only when required for processing. This also allows means for ensuring stable gas composition and flow to be maintained prior to switching into the process chamber.

The following equations indicate the steps of generating a  $\text{ClF}_3$  gas.



Equation 1 shows the first step in the formation of  $\text{ClF}_3$  from the reaction of  $\text{Cl}_2$  and  $\text{F}_2$ . This occurs at temperatures in the range of 250 to 500°C (preferably 350 to 400°C) at atmospheric pressure. The second reaction step shown in equation 2 occurs at lower temperatures in the range of 200 to 350°C (preferably 250 to 300°C) at atmospheric pressure. Hence, the  $\text{ClF}_3$  reactor system may comprise two different temperature controlled zones (or independent reactors), to control the individual reaction steps. Depending on the partial pressure of  $\text{ClF}_3$  required

a single reactor design may be sufficient, in this case operating at 250 to 350°C.

Details of the reactor design include:

1. premixing of the  $F_2$  and  $Cl_2$  using a static mixing technology, with low pressure drop throughout the reactor system (<50 Torr)
2. an HF trap located between the  $F_2$  generator and the mixing stage
3. a high temperature reactor using static mixing technology (to improve heat transfer to enhance reaction kinetics and ensure effective mixing of the gases  $Cl_2 + F_2 + ClF_x$ )
4. minimising temperature hot spots and ensuring that controlled thermal gradients are used.

The use of  $ClF_3$  necessitates a pre-conditioning of the gas lines and reactor/chamber surfaces to avoid any deleterious reactions, which may compromise safety (CJ Gugliemini and AD Johnson Semiconductor International, June 1999, pp 162-166). This pre-conditioning is necessary after every occasion where the surfaces have been exposed to the ambient atmosphere, which includes any maintenance operations. Ideally the pre-conditioning must be carried out using  $F_2$ . An additional feature of the present invention is the ability readily to perform the  $F_2$  pre-conditioning. Practically this can be achieved for the whole system by flowing the  $F_2$  only, with the reactor system between room and operational temperature, and

operating the respective valving in order to pre-condition the necessary components of the system. If the pre-conditioning (and thermal cycling) of the reactor system is to be avoided, then a bypass valving arrangement can be used.

Where  $\text{ClF}_3$  is required for plasma applications, it may be sufficient simply to combine the gases in a mixing manifold prior to entry into the plasma chamber without any specialised reaction chamber. As the plasma collisions serve to ionise the gas(es), so that the combination of radical and charged particle fluxes are used to carry out the processing, the function of  $\text{ClF}_3$  may be equally well served by flowing appropriate ratios of  $\text{F}_2:\text{Cl}_2$ . Figure 2 shows the result of etching silicon, comparing a  $\text{ClF}_3$  plasma with a  $\text{F}_2:\text{Cl}_2$  gas mixture. The result shows that the etch rate peaks at approximately 18-30% chlorine, which is in a similar range as the ratio of  $\text{Cl:F}$  as in  $\text{ClF}_3$ . Thus one embodiment of the present invention is the use of a  $\text{Cl}_2/\text{F}_2$  gas mixture (preferably at 15 to 35%  $\text{Cl}$ , preferably 20-30%  $\text{Cl}$ ) to replace the need for  $\text{ClF}_3$ .

One embodiment of the invention is the use of an additional  $\text{ClF}_x$  holding chamber 11 (shown in Figure 3) which serves to allow immediate gas flow on demand to reduce the processing time associated with generation startup or initialisation. The holding chamber is

controlled to a temperature in the range 25 to 200°C (preferably 25 to 100°C) at atmospheric pressure.

In Figure 3, items similar to those in the embodiment 8 Figure 3 are given similar reference numerals. In this embodiment  $F_2$  and  $Cl_2$  are supplied via respective control valves A and B to a pre-treatment static mixer 10. From the static mixer 10 the pre-mixed gases pass to a first reaction chamber 2a to allow reaction (1) above to take place and thence to a second reaction chamber 2b where reaction (2) takes place. The reaction mixture from the second reaction chamber 2b is then passed to a holding chamber 11, maintained at a required temperature and pressure, whence the reaction mixture passes via a valve 12 and flow meter 14 to the process chamber 1. The process chamber has an outlet connection to a pump system/abatement device 7,8. Also, the second reactor 2 may pass the reaction mixture direct to the pump system/abatement device 7,8 via a by-pass valve 15, to bypass the holding chamber 11 and the process chamber 1. The flow bypass may be required for stabilisation purposes or, where the holding chamber is not present, for disposing of the reaction mixture during loading/unloading of the process chamber.

Also shown in the Figure is a source 16 of a purge gas for allowing purging of the system, under control of a valve E.



CLAIMS

1. A  $\text{ClF}_3$  gas generation system wherein supply sources of chlorine and fluorine are connected into a gas reaction chamber enabling generation of  $\text{ClF}_3$  gas, and the reaction chamber has a valved outlet for the supply of the  $\text{ClF}_3$  gas.

2. A system according to claim 1, wherein the chlorine supply source comprises a cylinder of compressed chlorine or a chlorine generator.

3. A system according to claim 1 or claim 2, wherein the fluorine supply source is a fluorine generator.

4. A system according to any one of claims 1 to 3, wherein a control system is provided to control the rate of supply of gases from the two supply sources and through the valved outlet from the reaction chamber.

5. A system according to any one of claims 1 to 4, wherein the valved outlet from the reaction chamber is connected to a process chamber or processing tool or multiple tools in which the  $\text{ClF}_3$  gas will be utilised.

6. A system according to claim 5, wherein an abatement tool is connected from the output of the processing chamber or tool.

7. A system according to claim 6, wherein a bypass connection is provided from the reaction chamber to the abatement tool to enable the process to build up to a

stable composition and/or flow prior to supply of the generated  $\text{ClF}_3$  to the process chamber or tool.

8. A system according to claim 6, wherein a bypass connection is provided from the reaction chamber to the abatement tool to enable the flow of  $\text{ClF}_3$  to be switched into the process chamber as and when required to allow a continuous generation of  $\text{ClF}_3$ .

9. A method of generating  $\text{ClF}_3$  gas using a system as claimed in any one of claims 1 to 8, wherein the precursor gases are fed from the supply sources to the reaction chamber, a combination reaction is performed and the  $\text{ClF}_3$  reaction product is fed on to a local processing chamber or tool.

10. A method according to Claim 9 wherein the gasses formed are fed into a plasma chamber using  $\text{Cl}_2/\text{F}_2$  gas mixture, wherein the chlorine level is between 15-35%, preferably 20-30%.

11. A method according to Claim 9 wherein an additional  $\text{ClF}_x$  gas is provided in a holding chamber which allows immediate gas flow on demand to reduce processing time.

12. A method according to Claim 9 wherein the gas lines and reactor surfaces are pre-conditioned using  $\text{F}_2$ .

13. A gas generation system or method for generating  $\text{ClF}_3$  gas and substantially as herein described with reference to the accompanying drawings.

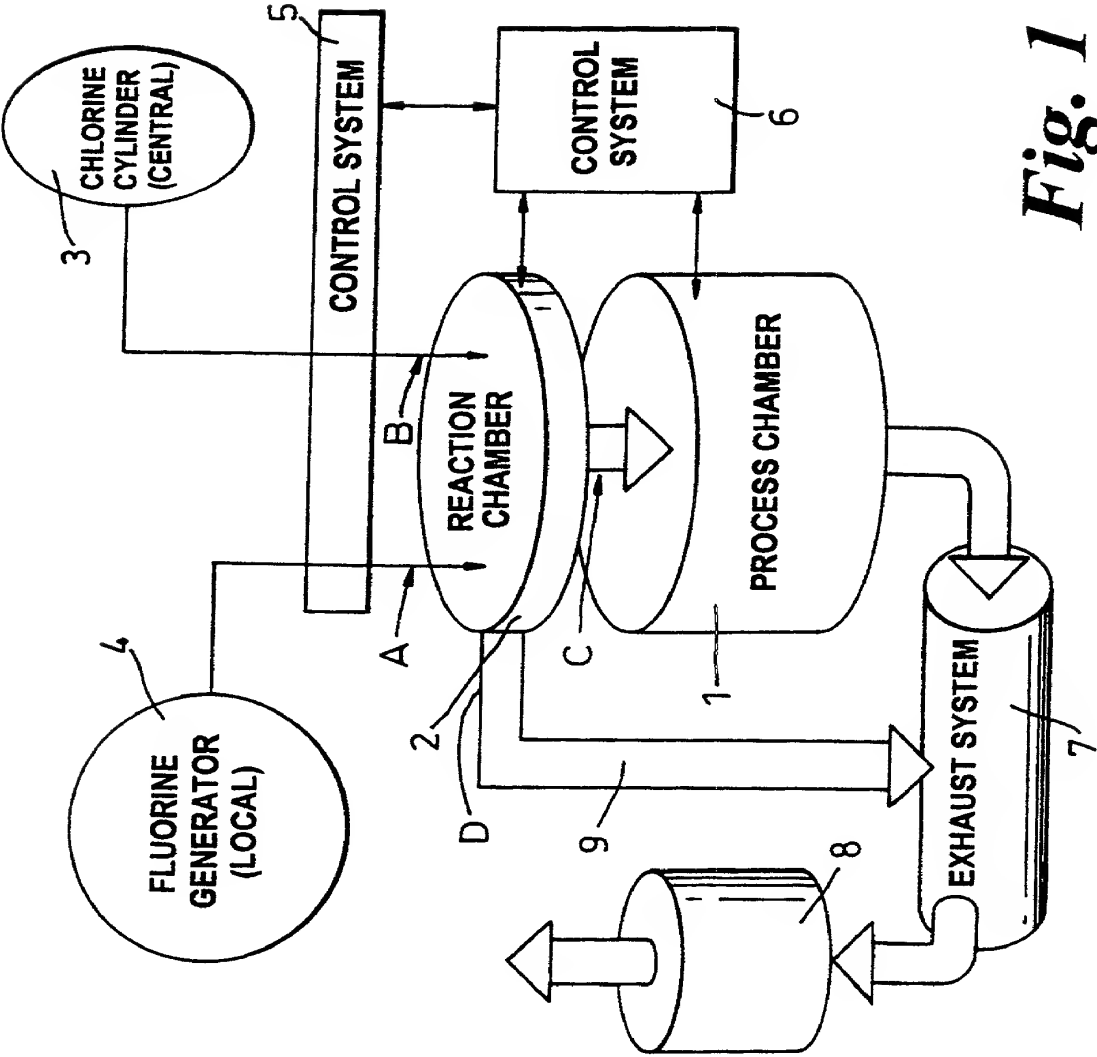
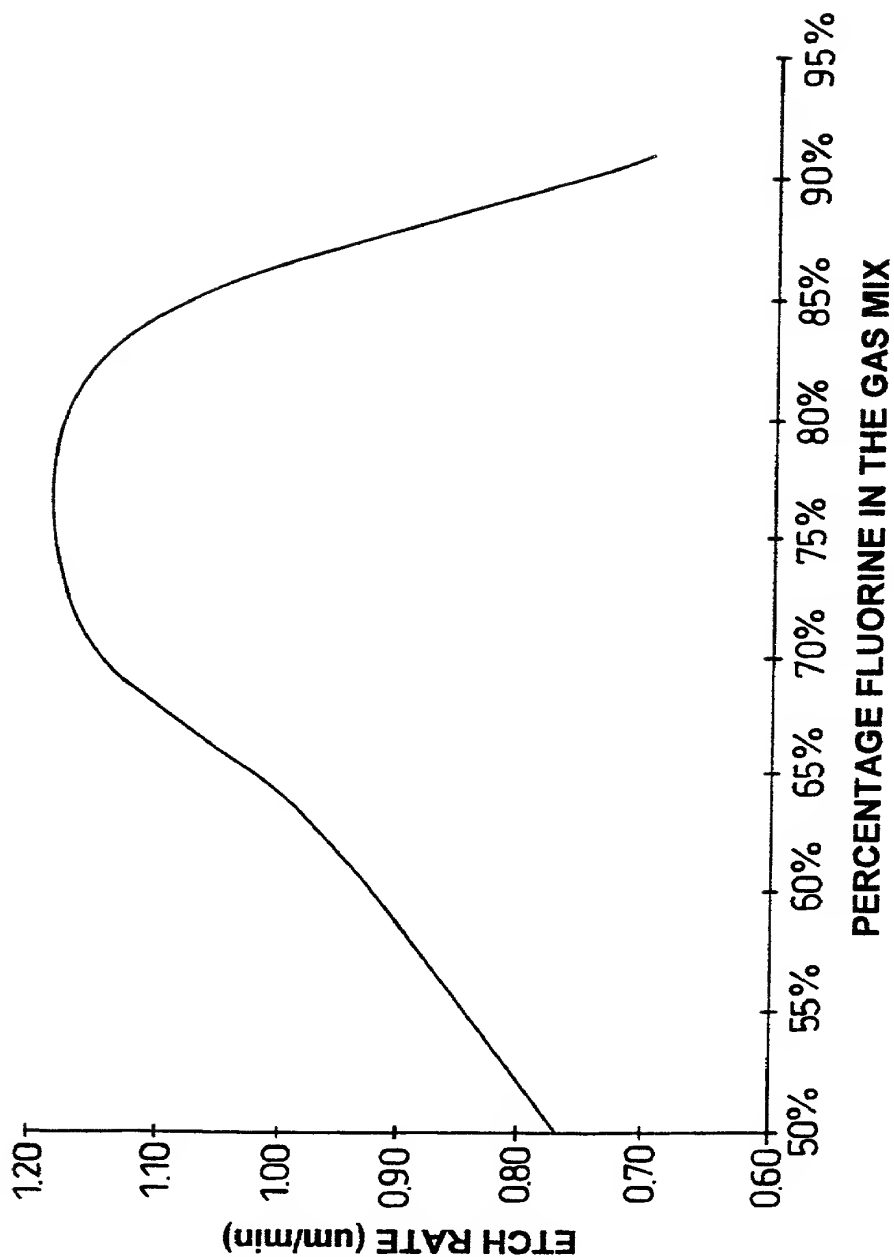


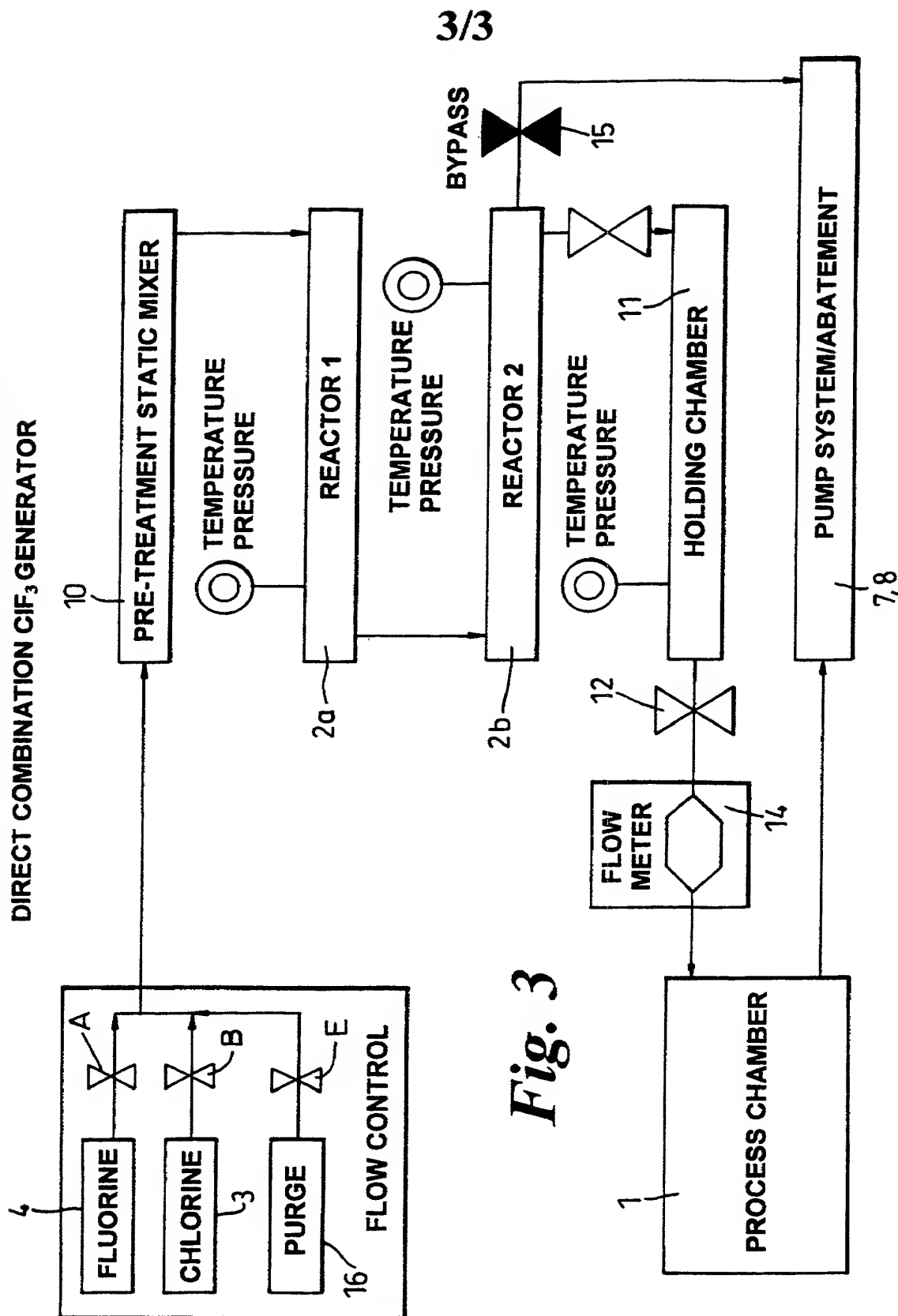
Fig. 1

2/3

# EFFECT OF $F_2 : Cl_2$ RATIO ON ETCH RATE



**Fig. 2** INFLUENCE OF GAS MIXTURE RATIO ON THE SILICON ETCH RATE



JONES VOLENTINE, L.L.C. (6/2000)

## DECLARATION AND POWER OF ATTORNEY FOR U.S. PATENT APPLICATION

(X) Original ( ) Supplemental ( ) Substitute ( ) PCT ( ) Design

As a below named inventor, I hereby declare that: my residence, post office address and citizenship are as stated below next to my name; that I verily believe that I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural inventors are named below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

**TITLE: CHLOROTRIFLUORINE GAS GENERATOR SYSTEM**

of which is described and claimed in:

( ) the attached specification, or

( ) the specification in the application Serial No. \_\_\_\_\_ filed \_\_\_\_\_

and with amendments through \_\_\_\_\_ (if applicable), or

(X) the specification in International Application No. PCT/GB00/00796, filed 6 MARCH 2000,

and as amended on \_\_\_\_\_ (if applicable).

I hereby state that I have reviewed and understand the content of the above-identified specification, including the claims, as amended by any amendment(s) referred to above.

I acknowledge my duty to disclose information of which I am aware which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, §1.56(a).

I hereby claim foreign priority benefits under Title 35, United States Code, §119 (and §172 if this application is for a Design) of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

COUNTRY	APPLICATION NO.	DATE OF FILING	PRIORITY CLAIMED
GREAT BRITAIN	9904925.6	4 MARCH 1999	YES
GREAT BRITAIN	9909856.8	29 APRIL 1999	YES

I hereby claim the benefit under Title 35, United States Code, §120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, §112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, §1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application:



APPLICATION SERIAL NO.	U.S. FILING DATE	STATUS: PATENTED, PENDING, ABANDONED

And I hereby appoint Raymond C. Jones, Reg. No. 34,631 and Adam C. Volentine, Reg. No. 33,289, of the firm of JONES VOLENTINE, L.L.C., jointly and severally, attorneys to prosecute this application and to transact all business in the U.S. Patent and Trademark Office connected therewith.

I hereby authorize the U.S. attorneys named herein to accept and follow instructions from WYNNE-JONES, LAINE & JAMES as to any action to be taken in the U.S. Patent and Trademark Office regarding this application without direct communication between the U.S. attorneys and myself. In the event of a change in the persons from whom instructions may be taken, the U.S. attorneys named herein will be so notified by me.

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I further declare that all statements made herein of my own knowledge are true, and that all statements on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

1st Inventor *J. Bhardwaj* Date *22<sup>nd</sup> October 2000*  
*Jyoti Kiron BHARDWAJ*  
 2nd Inventor *N. Shepherd* Date *22. 10. 2000*  
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